

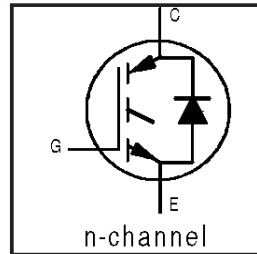
# IRG4PH30KDPbF

## INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

## Short Circuit Rated UltraFast IGBT

### Features

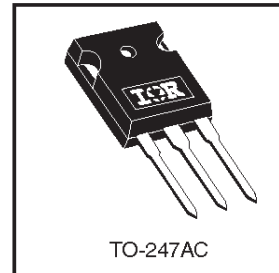
- High short circuit rating optimized for motor control,  $t_{sc} = 10\mu s$ ,  $V_{CC} = 720V$ ,  $T_J = 125^\circ C$ ,  $V_{GE} = 15V$
- Combines low conduction losses with high switching speed
- Tighter parameter distribution and higher efficiency than previous generations
- IGBT co-packaged with HEXFRED™ ultrafast, ultrasoft recovery antiparallel diodes



$V_{CES} = 1200V$   
 $V_{CE(on)} \text{ typ.} = 3.10V$   
@  $V_{GE} = 15V$ ,  $I_C = 10A$

### Benefits

- Latest generation 4 IGBT's offer highest power density motor controls possible
- HEXFRED™ diodes optimized for performance with IGBTs. Minimized recovery characteristics reduce noise, EMI and switching losses
- This part replaces IRGPH30MD2 products
- For hints see design tip 97003
- Lead-Free



### Absolute Maximum Ratings

|                           | Parameter  | Max.                | Units      |
|---------------------------|--|---------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage                     | 1200                | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 20                  | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 10                  |            |
| $I_{CM}$                  | Pulsed Collector Current ①                       | 40                  |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②                 | 40                  |            |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current                 | 10                  |            |
| $I_{FM}$                  | Diode Maximum Forward Current                    | 40                  |            |
| $t_{sc}$                  | Short Circuit Withstand Time                     | 10                  | $\mu s$    |
| $V_{GE}$                  | Gate-to-Emitter Voltage                          | $\pm 20$            | V          |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 100                 | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 42                  |            |
| $T_J$                     | Operating Junction and Storage Temperature Range | -55 to +150         | $^\circ C$ |
| $T_{STG}$                 |  |                     |            |
|                           |  |                     |            |
|                           | Mounting Torque, 6-32 or M3 Screw.               | 10 lbf•in (1.1 N•m) |            |

### Thermal Resistance

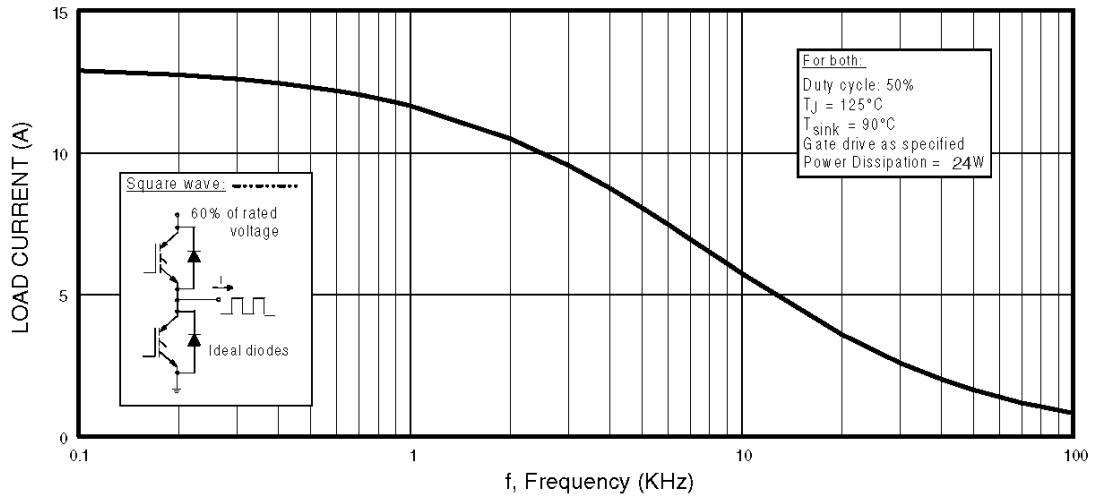
|                 | Parameter                                 | Min. | Typ.     | Max. | Units        |
|-----------------|---|------|----------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | ---  | ---      | 1.2  | $^\circ C/W$ |
| $R_{\theta JC}$ | Junction-to-Case - Diode                  | ---  | ---      | 2.5  |              |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface       | ---  | 0.24     | ---  |              |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | ---  | ---      | 40   |              |
| Wt              | Weight                                    | ---  | 6 (0.21) | ---  | g (oz)       |

## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

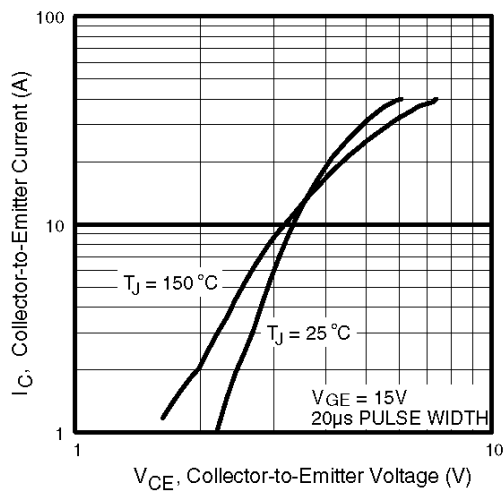
|  | Parameter   | Min. | Typ. | Max. | Units | Conditions  |
|--|---|------|------|------|-------|---|
| V <sub>(BR)CES</sub>                   | Collector-to-Emitter Breakdown Voltage <sup>③</sup> | 1200 | —    | —    | V     | V <sub>GE</sub> = 0V, I <sub>C</sub> = 250μA                          |
| ΔV <sub>(BR)CES</sub> /ΔT <sub>J</sub> | Temperature Coeff. of Breakdown Voltage             | —    | 0.19 | —    | V/°C  | V <sub>GE</sub> = 0V, I <sub>C</sub> = 1.0mA                          |
| V <sub>CE(on)</sub>                    | Collector-to-Emitter Saturation Voltage             | —    | 3.10 | 4.2  | V     | I <sub>C</sub> = 10A V <sub>GE</sub> = 15V                            |
|  |   | —    | 3.90 | —    |       | I <sub>C</sub> = 20A See Fig. 2, 5                                    |
|  |   | —    | 3.01 | —    |       | I <sub>C</sub> = 10A, T <sub>J</sub> = 150°C                          |
| V <sub>GE(th)</sub>                    | Gate Threshold Voltage                              | 3.0  | —    | 6.0  |       | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA            |
| ΔV <sub>GE(th)</sub> /ΔT <sub>J</sub>  | Temperature Coeff. of Threshold Voltage             | —    | -12  | —    | mV/°C | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA            |
| g <sub>fe</sub>                        | Forward Transconductance <sup>④</sup>               | 4.3  | 6.5  | —    | S     | V <sub>CE</sub> = 100V, I <sub>C</sub> = 10A                          |
| I <sub>CES</sub>                       | Zero Gate Voltage Collector Current                 | —    | —    | 250  | μA    | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 1200V                         |
|  |   | —    | —    | 3500 |       | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 1200V, T <sub>J</sub> = 150°C |
| V <sub>FM</sub>                        | Diode Forward Voltage Drop                          | —    | 3.4  | 3.8  | V     | I <sub>C</sub> = 10A See Fig. 13                                      |
|  |   | —    | 3.3  | 3.7  |       | I <sub>C</sub> = 10A, T <sub>J</sub> = 150°C                          |
| I <sub>GES</sub>                       | Gate-to-Emitter Leakage Current                     | —    | —    | ±100 | nA    | V <sub>GE</sub> = ±20V  |

## Switching Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

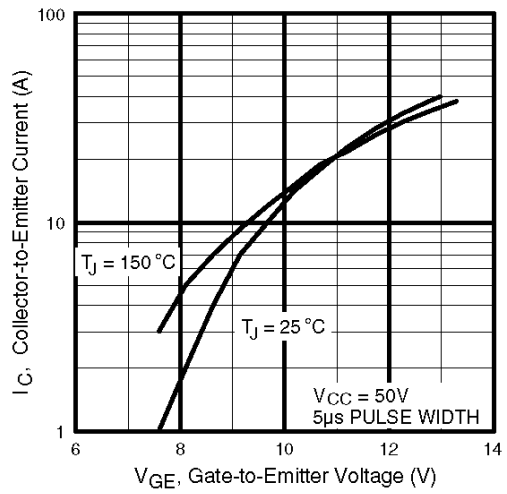
|                          | Parameter   | Min. | Typ. | Max. | Units | Conditions   |
|--------------------------|---|------|------|------|-------|--|
| Q <sub>g</sub>           | Total Gate Charge (turn-on)                               | —    | 53   | 80   | nC    | I <sub>C</sub> = 10A   |
| Q <sub>ge</sub>          | Gate - Emitter Charge (turn-on)                           | —    | 9.0  | 14   |       | V <sub>CC</sub> = 400V See Fig. 8  |
| Q <sub>gc</sub>          | Gate - Collector Charge (turn-on)                         | —    | 21   | 32   |       | V <sub>GE</sub> = 15V  |
| t <sub>d(on)</sub>       | Turn-On Delay Time  | —    | 39   | —    | ns    | T <sub>J</sub> = 25°C<br>I <sub>C</sub> = 10A, V <sub>CC</sub> = 800V<br>V <sub>GE</sub> = 15V, R <sub>G</sub> = 23Ω   |
| t <sub>r</sub>           | Rise Time   | —    | 84   | —    |       |  |
| t <sub>d(off)</sub>      | Turn-Off Delay Time                                       | —    | 220  | 340  |       |  |
| t <sub>f</sub>           | Fall Time   | —    | 90   | 140  |       |  |
| E <sub>on</sub>          | Turn-On Switching Loss                                    | —    | 0.95 | —    |       |  |
| E <sub>off</sub>         | Turn-Off Switching Loss                                   | —    | 1.15 | —    |       |  |
| E <sub>ts</sub>          | Total Switching Loss                                      | —    | 2.10 | 2.6  |       |  |
| t <sub>sc</sub>          | Short Circuit Withstand Time                              | 10   | —    | —    | μs    | V <sub>CC</sub> = 720V, T <sub>J</sub> = 125°C<br>V <sub>GE</sub> = 15V, R <sub>G</sub> = 5.0Ω   |
| t <sub>d(on)</sub>       | Turn-On Delay Time  | —    | 42   | —    | ns    | T <sub>J</sub> = 150°C, See Fig. 10, 11, 18<br>I <sub>C</sub> = 10A, V <sub>CC</sub> = 800V<br>V <sub>GE</sub> = 15V, R <sub>G</sub> = 23Ω,<br>Energy losses include "tail" and diode reverse recovery |
| t <sub>r</sub>           | Rise Time   | —    | 79   | —    |       |  |
| t <sub>d(off)</sub>      | Turn-Off Delay Time                                       | —    | 540  | —    |       |  |
| t <sub>f</sub>           | Fall Time   | —    | 97   | —    |       |  |
| E <sub>ts</sub>          | Total Switching Loss                                      | —    | 3.5  | —    | mJ    |  |
| L <sub>E</sub>           | Internal Emitter Inductance                               | —    | 13   | —    | nH    | Measured 5mm from package  |
| C <sub>ies</sub>         | Input Capacitance   | —    | 800  | —    | pF    | V <sub>GE</sub> = 0V<br>V <sub>CC</sub> = 30V See Fig. 7<br>f = 1.0MHz   |
| C <sub>oes</sub>         | Output Capacitance  | —    | 60   | —    |       |  |
| C <sub>res</sub>         | Reverse Transfer Capacitance                              | —    | 14   | —    |       |  |
| t <sub>rr</sub>          | Diode Reverse Recovery Time                               | —    | 50   | 76   | ns    | T <sub>J</sub> = 25°C See Fig. 14  |
|                          |   | —    | 72   | 110  |       | T <sub>J</sub> = 125°C   |
| I <sub>rr</sub>          | Diode Peak Reverse Recovery Current                       | —    | 4.4  | 7.0  | A     | T <sub>J</sub> = 25°C See Fig. 15  |
|                          |   | —    | 5.9  | 8.8  |       | T <sub>J</sub> = 125°C   |
| Q <sub>rr</sub>          | Diode Reverse Recovery Charge                             | —    | 130  | 200  | nC    | T <sub>J</sub> = 25°C See Fig. 16  |
|                          |   | —    | 250  | 380  |       | T <sub>J</sub> = 125°C   |
| di <sub>(rec)</sub> M/dt | Diode Peak Rate of Fall of Recovery During t <sub>b</sub> | —    | 210  | —    | A/μs  | T <sub>J</sub> = 25°C See Fig. 17  |
|                          |   | —    | 180  | —    |       | T <sub>J</sub> = 125°C   |



**Fig. 1** - Typical Load Current vs. Frequency  
 (Load Current =  $I_{\text{RMS}}$  of fundamental)

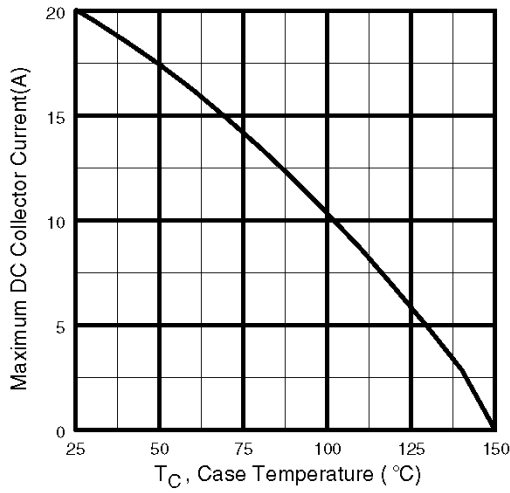


**Fig. 2** - Typical Output Characteristics

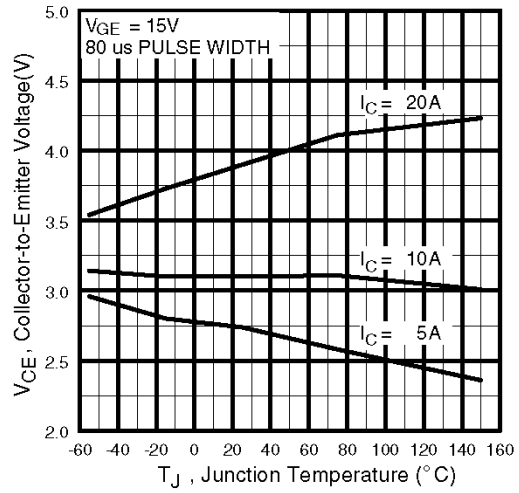


**Fig. 3** - Typical Transfer Characteristics

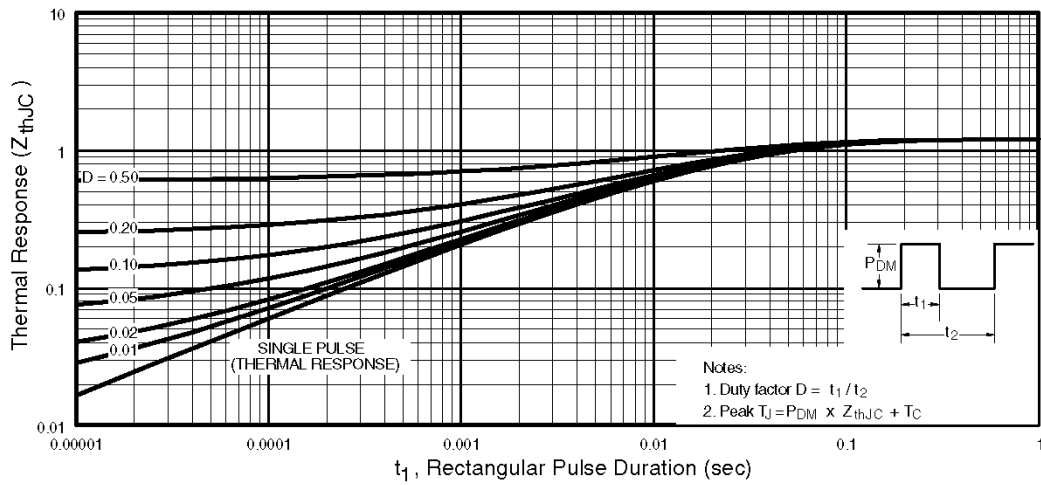
# IRG4PH30KDPbF



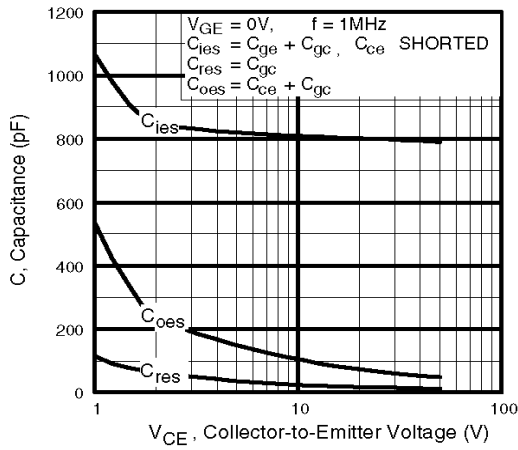
**Fig. 4** - Maximum Collector Current vs. Case Temperature



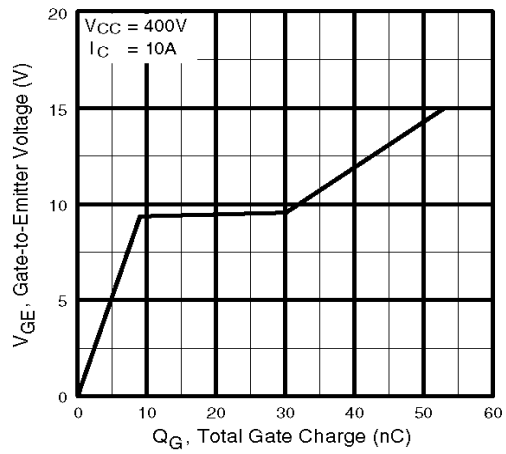
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



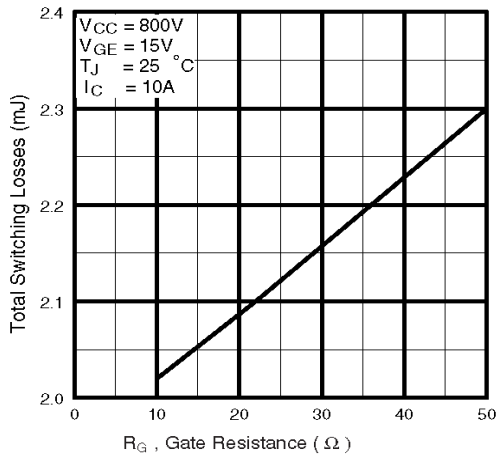
**Fig. 6** - Maximum Effective Transient Thermal Impedance, Junction-to-Case



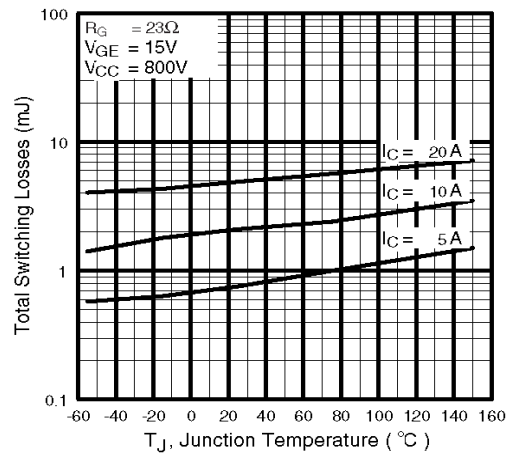
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage



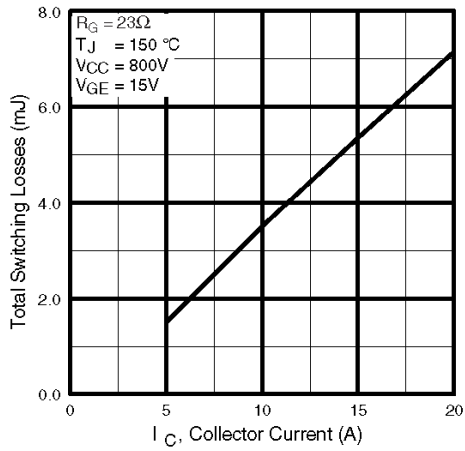
**Fig. 9** - Typical Switching Losses vs. Gate Resistance



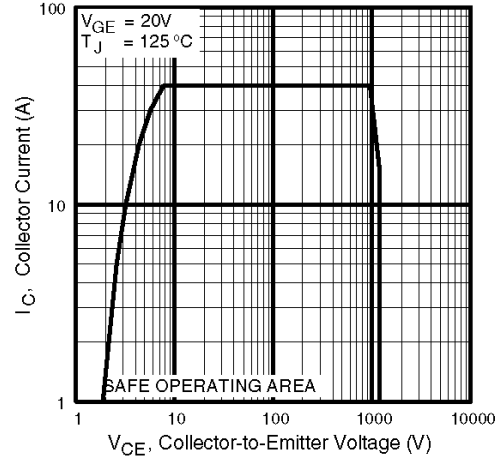
**Fig. 10** - Typical Switching Losses vs. Junction Temperature

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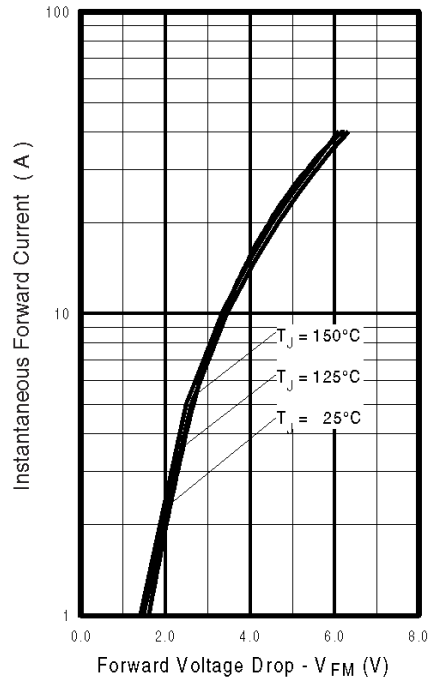
International  
**IR** Rectifier



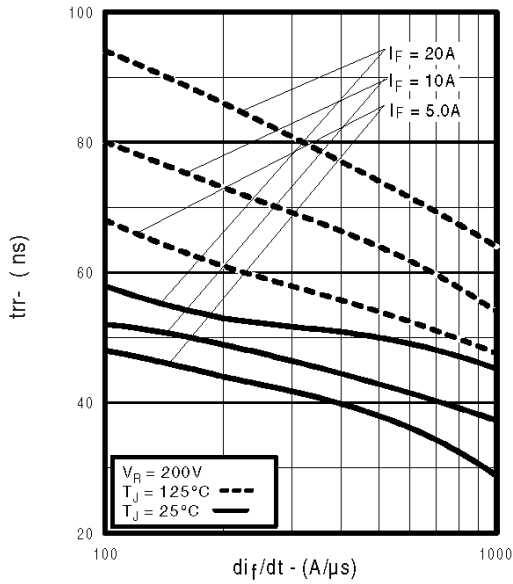
**Fig. 11** - Typical Switching Losses vs. Collector Current



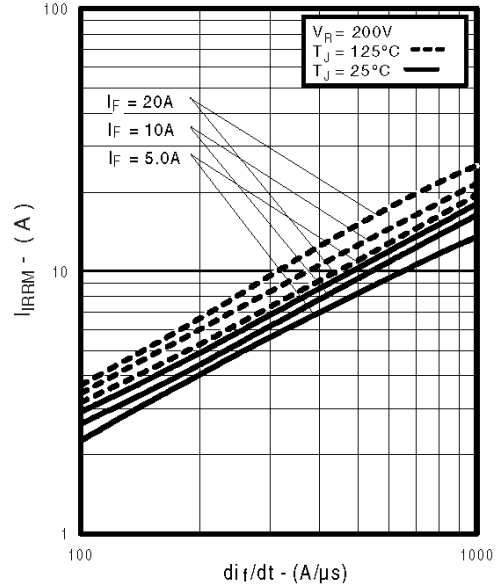
**Fig. 12** - Turn-Off SOA



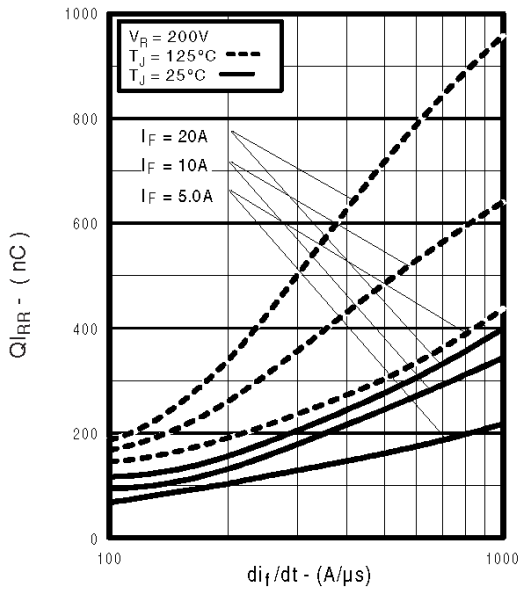
**Fig. 13** - Typical Forward Voltage Drop vs. Instantaneous Forward Current



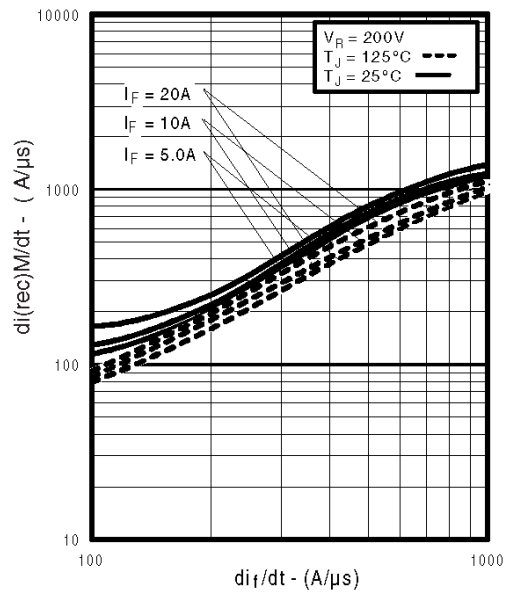
**Fig. 14** - Typical Reverse Recovery vs.  $di/dt$



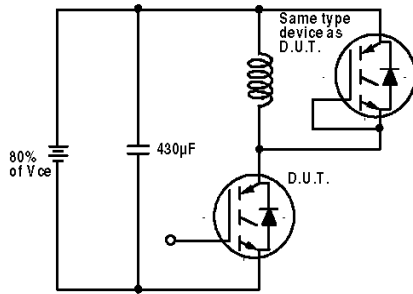
**Fig. 15** - Typical Recovery Current vs.  $di/dt$



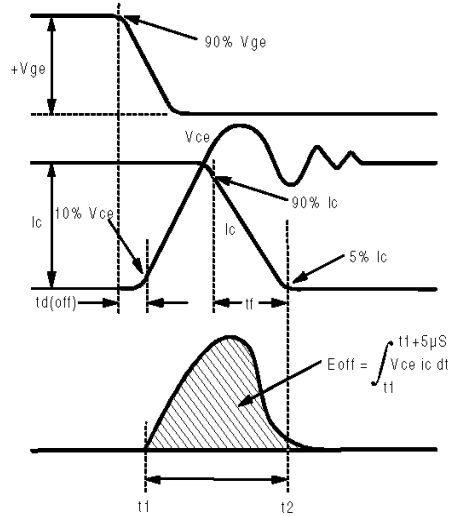
**Fig. 16** - Typical Stored Charge vs.  $di/dt$



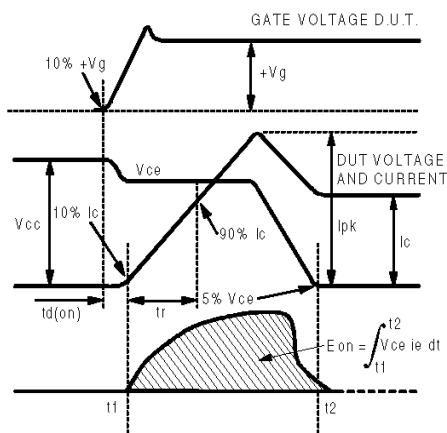
**Fig. 17** - Typical  $di_{(rec)M}/dt$  vs.  $di/dt$



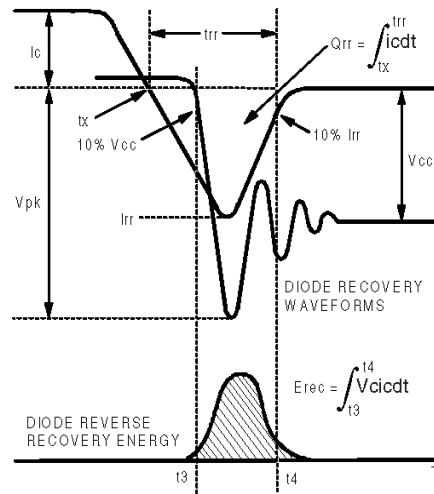
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off}(\text{diode})$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$



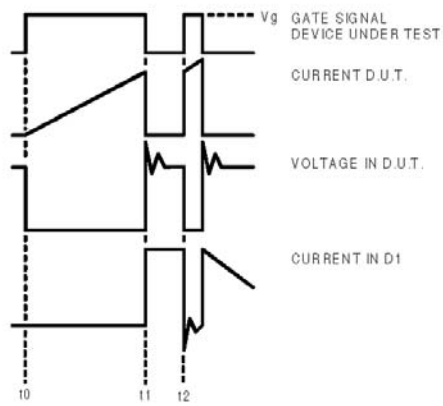


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

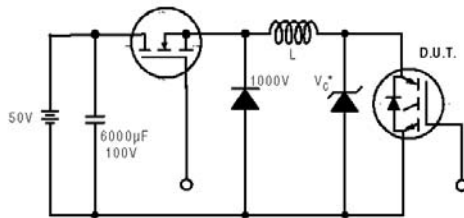


Figure 19. Clamped Inductive Load Test Circuit

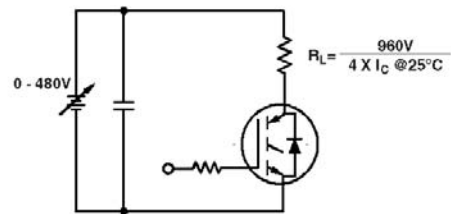


Figure 20. Pulsed Collector Current Test Circuit

# IRG4PH30KDPbF

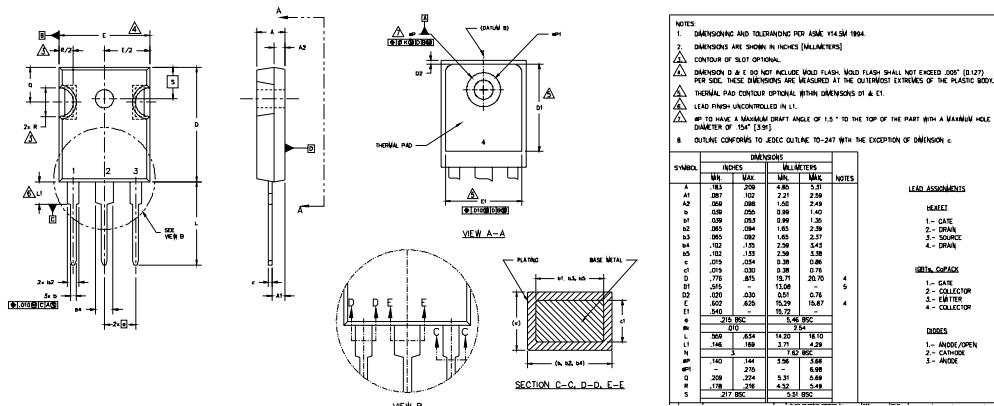
International  
Rectifier

## Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\%(V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G=23\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.

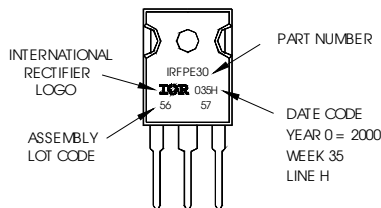
## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



## TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFP30  
WITH ASSEMBLY  
LOT CODE 5667  
ASSEMBLED ON WW 35, 2000  
IN THE ASSEMBLY LINE "H"  
**Note:** "P" in assembly line  
position indicates "Lead-Free"



Data and specifications subject to change without notice.

International  
Rectifier

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